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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
09/909,074	07/19/2001	Joyce S.Oey Hewett	2000.075200/TT4629	9763	
23720	7590 06/13/2003				
WILLIAMS, MORGAN & AMERSON, P.C.			EXAMINER		
	10333 RICHMOND, SUITE 1100 HOUSTON, TX 77042			NGUYEN, KHIEM D	
			ART UNIT	PAPER NUMBER	
		2823			
			DATE MAILED: 06/13/2003		

Please find below and/or attached an Office communication concerning this application or proceeding.

		Im_			
•	Application No.	Applicant(s)			
Advisory Action	09/909,074	HEWETT ET AL.			
,	Examiner	Art Unit			
	Khiem D Nguyen	2823			
The MAILING DATE of this communication app	ears on the cover sheet with the	correspondence address			
THE REPLY FILED 09 May 2003 FAILS TO PLACE THE REPLY FILED 09 May 2003 FAILS TO PLACE THE PROPERTY IN THE PLACE THE PROPERTY IN THE PLACE THE PROPERTY IN THE PLACE TH	avoid abandonment of this appl (1) a timely filed amendment wh	lication. A proper reply to a nich places the application in			
	EPLY [check either a) or b)]	,			
a) The period for reply expires 4 months from the mailing date b)  The period for reply expires on: (1) the mailing date of this Adevent, however, will the statutory period for reply expire later to ONLY CHECK THIS BOX WHEN THE FIRST REPLY WAS 706.07(f).  Extensions of time may be obtained under 37 CFR 1.136(a). The drave been filed is the date for purposes of determining the period of exte 87 CFR 1.17(a) is calculated from: (1) the expiration date of the shortenes b) above, if checked. Any reply received by the Office later than three meanned patent term adjustment. See 37 CFR 1.704(b).	dvisory Action, or (2) the date set forth in the han SIX MONTHS from the mailing date of FILED WITHIN TWO MONTHS OF TILES on which the petition under 37 CFR 1 nation and the corresponding amount of the statutory period for reply originally set in the set is the set of the set of the set in the set is the set of the set in the se	of the final rejection. HE FINAL REJECTION. See MPEP  .136(a) and the appropriate extension fee he fee. The appropriate extension fee under hthe final Office action; or (2) as set forth in			
1. A Notice of Appeal was filed on Appellant 37 CFR 1.192(a), or any extension thereof (37 Cl		·			
2. The proposed amendment(s) will not be entered because:					
(a) they raise new issues that would require further consideration and/or search (see NOTE below);					
(b) ☐ they raise the issue of new matter (see Note below);					
(c) they are not deemed to place the application in better form for appeal by materially reducing or simplifying the issues for appeal; and/or					
(d) they present additional claims without cance NOTE:	eling a corresponding number o	f finally rejected claims.			
3. Applicant's reply has overcome the following reje	ction(s):				
4. Newly proposed or amended claim(s) woul canceling the non-allowable claim(s).	d be allowable if submitted in a	separate, timely filed amendment			
5.☑ The a)☐ affidavit, b)☐ exhibit, or c)☑ request for reconsideration has been considered but does NOT place the application in condition for allowance because: <u>See Continuation Sheet</u> .					
6. The affidavit or exhibit will NOT be considered be raised by the Examiner in the final rejection.	ecause it is not directed SOLEL	Y to issues which were newly			
7. For purposes of Appeal, the proposed amendmen explanation of how the new or amended claims versions.					
The status of the claim(s) is (or will be) as follows	<b>S</b> :				
Claim(s) allowed: none.		·			
Claim(s) objected to: none.					
Claim(s) rejected: <u>1,2,4-13 and 15</u> .	•				
Claim(s) withdrawn from consideration:					
8. The proposed drawing correction filed on i	s a)□ approved or b)□ disa	pproved by the Examiner.			
9.  Note the attached Information Disclosure Statem	ent(s)( PTO-1449) Paper No(s).				
10. Other:					
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Continuation of 5. does NOT place the application in condition for allowance because: In response to applicant's argument that the Chen patent does not disclose or suggest any electroplating parameter may be used to control the thickness of the film, Chen discloses that the thickness of a conductive layer may be controlled by varying the electroplating bath conditions, such as, by a chemical concentration in the plating solution, pH value of the solution, the temperature of the electroplating bath, the deposition rate or the length of time of electroplating (col. 8, lines 5-17). In view of recognition that the chemical concentration affect the deposition rate and, therefor affect the thickness in a given deposition time. It would have been obvious to one of ordinary skill in the art of making semiconductor devices to combine the teaching of Wilson and Chen to achieve revising the recipe in Wilson by changing the chemical concentration.

Olik Chaudhuri Supervisory Patent Examiner Technology Center 2800